

TOSHIBA CORPORATION

Toshiba Electronic Devices & Storage Corporation

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Date: July 26, 2019

Ref. No.: O-HKN-19-00029E

To: **DIGI KEY CORPORATION**

Dear Sir/ Madam:

Change in Packing Material < Change in Emboss reel Supplier >

We greatly appreciate your continued business.

This is to notify our customers of our plan to change wafer fab of our products supplied to you.

Full details of the planned change are given in the following page.

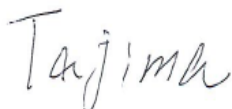
If you have any questions or inquiry regarding this change, please inform our Sales representatives nearest you as soon as possible.

We appreciate your understanding and cooperation.

Yours faithfully,

Reviewed by H. Kashima

Approved by I.Tajima, Manager



Quality Reliability Service Group Oita Office

Quality & Reliability Engineering Dept.

Toshiba Electronic Devices & Storage Corporation

Change in Packing Material < Change in Emboss reel Supplier >

1. Product to be Affected : See Attached file for the list of affected products.

2. Description of Change : Reel : A (Supplier : D) ⇒ Reel : B (Supplier : G)
(See Attached file for details)

3. Reason of Change : supply risk avoidance by aging of equipment

4. Scheduled Date of Change : We will switch after the end of stock from October 2019.

5. Remark : If you have any questions or requests regarding this change, please inform our Sales representatives nearest you as soon as possible.

